

# SPECIFICATION

*PART NO. : LT6U13-AH-URC2*  
HIGH POWER AUTOMATIVE LED



Approved by

Checked by

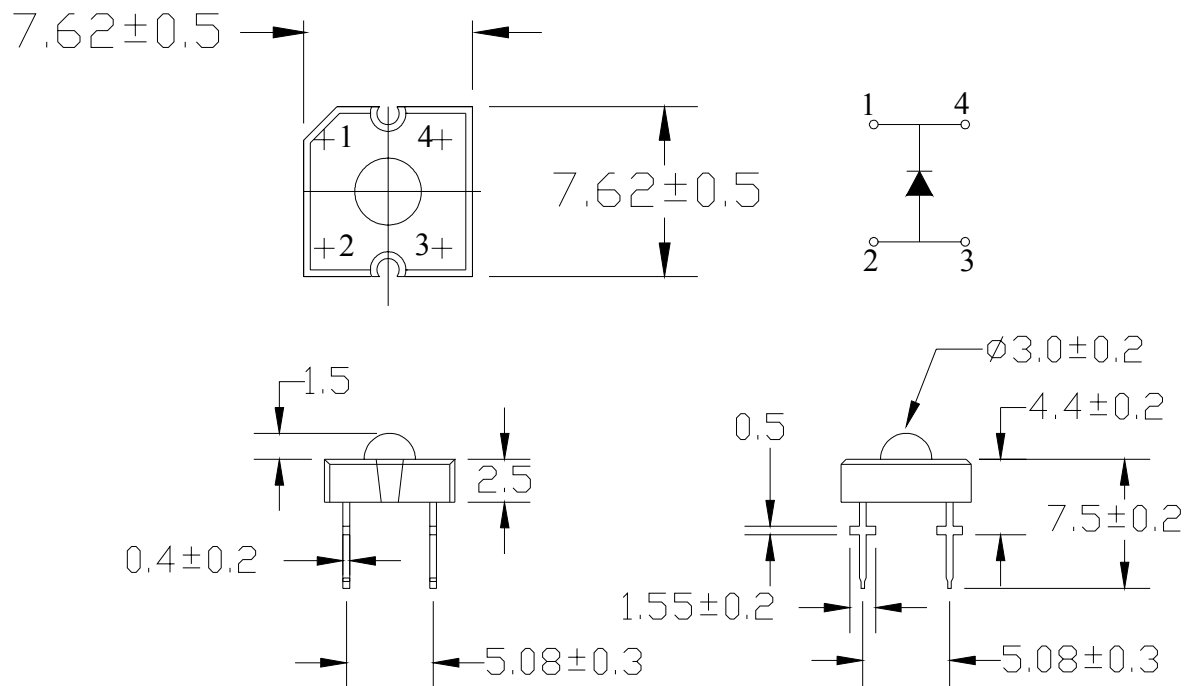
Prepared by

*Sam*

*Lian*

*Show*

## Package Dimensions



### Notes:

1. ALL DIMENSIONS ARE IN mm.
2. TOLERANCE IS  $\pm 0.25$ mm UNLESS OTHERWISE NOTED.

## Description

Part No.	LED Chip		Lens Color
	Material	Emitting Color	
LT6U13-AH-URC2	AlGaInP/GaAs	Super Red	Water Clear

**Absolute Maximum Ratings at Ta=25**

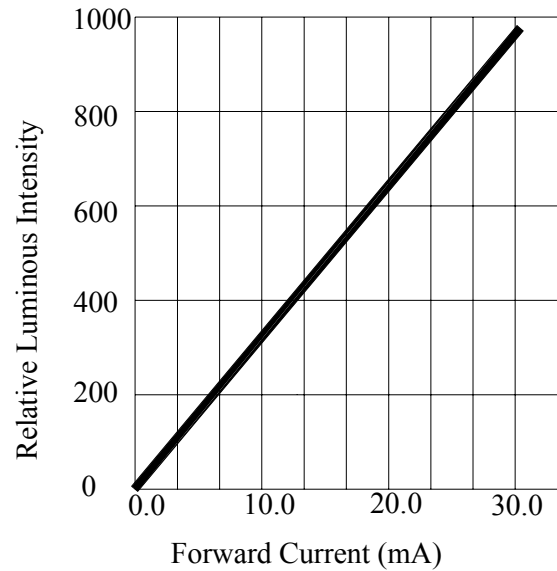
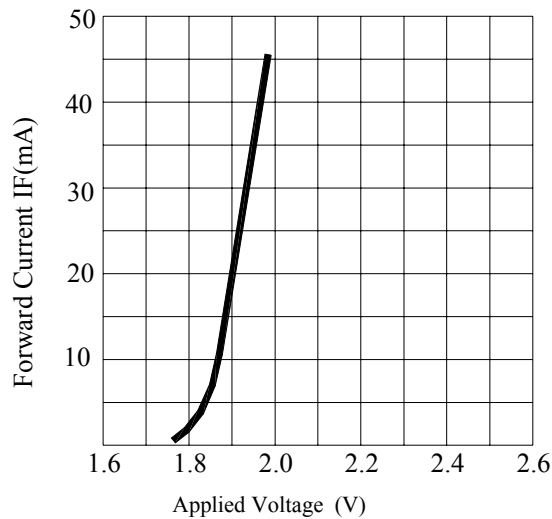
Parameter	Symbol	Rating	Unit
Power Dissipation	P <sub>D</sub>	72	mW
Reverse Voltage	V <sub>R</sub>	5	V
D.C. Forward Current	I <sub>f</sub>	30	mA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	I <sub>f</sub> (Peak)	100	mA
Operating Temperature Range	T <sub>opr.</sub>	-25 to +85	
Storage Temperature Range	T <sub>stg.</sub>	-40 to +100	
Lead Soldering Temp. (1.6mm from body) for 5 seconds.		260	

**Electrical and Optical Characteristics:**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Intensity	I <sub>v</sub>	I <sub>f</sub> =20mA	370	620		mcd
Forward Voltage	V <sub>f</sub>	I <sub>f</sub> =20mA		1.9	2.4	V
Peak Wavelength	λ <sub>P</sub>	I <sub>f</sub> =20mA		639		nm
Dominant Wavelength	λ <sub>D</sub>	I <sub>f</sub> =20mA		630		nm
Reverse Current	I <sub>r</sub>	V <sub>r</sub> =5V			100	μA
Viewing Angle	2 1/2	I <sub>f</sub> =20mA		60		deg
Spectrum Line Halfwidth	Δλ	I <sub>f</sub> =20mA		20		nm

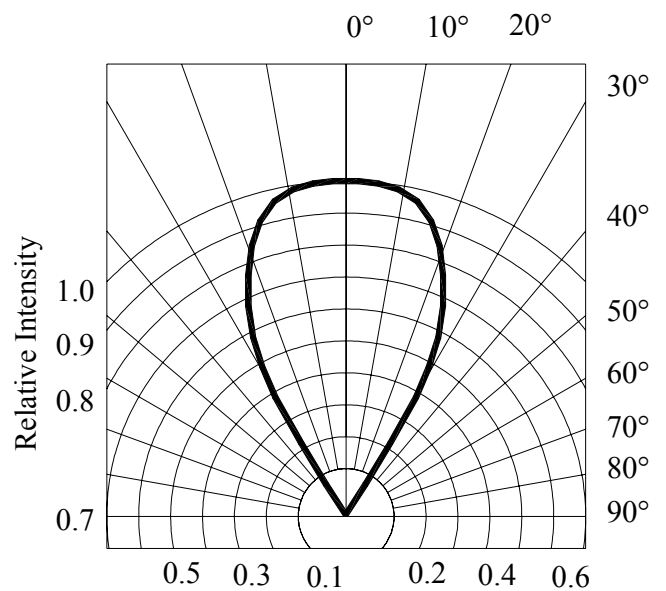
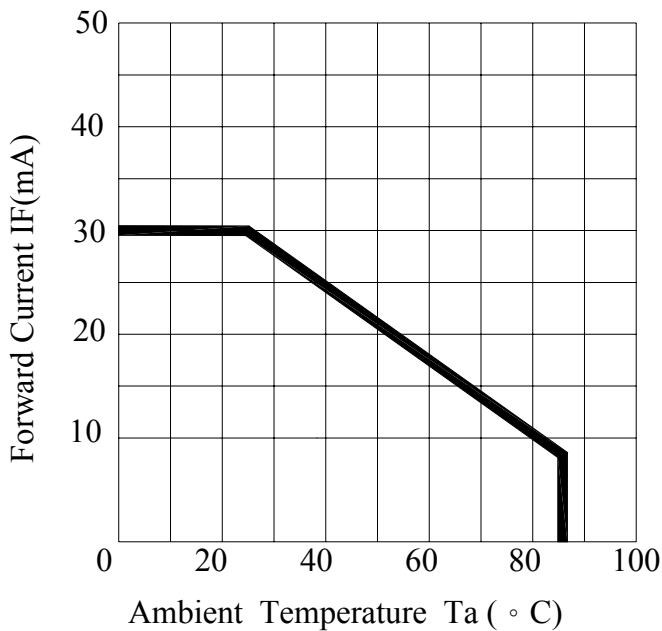
## Typical Electrical/Optical Characteristic Curves

(25 Ambient Temperature Unless Otherwise Noted)



Forward Current VS. Applied Voltage

Forward Current VS. Luminous Intensity



Ambient Temperature vs. Forward Current

Radiation Diagram

## Precautions:

### TAKE NOTE OF THE FOLLOWING IN USE OF LED

#### 1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130°C.

At a temperature exceeding this limit, the coefficient of linear expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

#### 2. Soldering

Please be careful on the following at soldering.

After soldering, avoid applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

##### (1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

##### (2) Solder dip: Preheat: 90°C max. (Backside of PCB), Within 120 seconds

Solder bath: 250°C max. (Solder temperature), Within 5 seconds

##### (3) Soldering iron : 250°C max. (Temperature of soldering iron tip), Within 3 seconds

#### 3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same

#### 4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120°C max. Baking time: Within 60 seconds

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

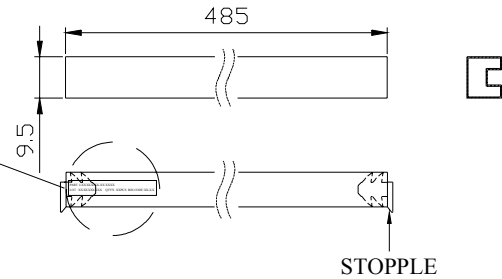
**ENCASED TYPE**

TUBE:

QUANTITY: 60 PCS

PART NO :LTXXXX-XX

LOT :XXXXXXXXXX QTY'S :XXPCS BIN CODE:XX-XX

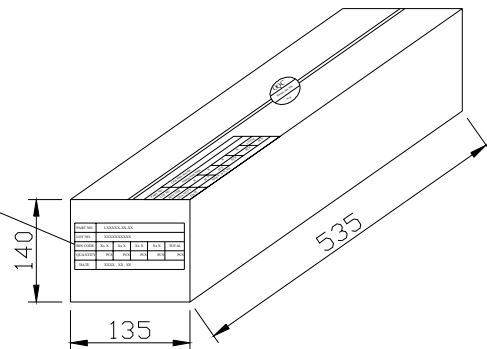


INNER BOX

QUANTITY: 140 tubes

TOTAL: 8400 PCS

PART NO.	LXXXX-XX-XX				
LOT NO.	XXXXXXXXXX				
BIN CODE	Xx X	Xx X	Xx X	Xx X	TOTAL
QUANTITY	PCS	PCS	PCS	PCS	PCS
DATE	XXXX, XX, XX				



OUTER CARTON

QUANTITY: 4 BOX

TOTAL: 33,600 PCS

C/T NO. 箱 號	XX
PART NO. 料 號	LXXXX-XX-XX
QUANTITY 數 量	PCS
N.W. 淨 重	KGS
G.W. 毛 重	KGS
REMARK 備 註	

